





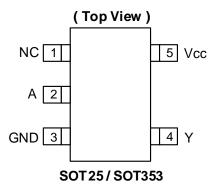
Description

The 74LVC1G34Q is an automotive-compliant, single buffer gate with a standard push-pull output. The device is designed for operation with a power supply range of 1.65V to 5.5V. The inputs are tolerant to 5.5V allowing this device to be used in a mixed voltage environment. The device is fully specified for partial power down applications using Ioff. The Ioff circuitry disables the output preventing damaging current backflow when the device is powered down.

The gate performs the positive Boolean function:

Y = A

Pin Assignments



Features

- Grade 1 Ambient Temperature Operation: -40°C to +125°C
- Wide Supply Voltage Range from 1.65V to 5.5V
- ± 24mA Output Drive at 3.3V
- CMOS Low Power Consumption
- Ioff Supports Partial-Power-Down Mode Operation
- Inputs Accept up to 5.5V Regardless of Vcc Level
- ESD Protection Tested per AEC-Q100
- Exceeds 2000V Human Body Model (AEC-Q100-002)
- Exceeds 1000V Charged Device Model (AEC-Q100-011)
- Latch-Up Exceeds 100mA (AEC-Q100-004)
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The 74LVC1G34Q is suitable for automotive applications requiring specific change control; this part is AEC-Q100 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Applications

- Voltage Level Shifting
- General Purpose Logic
- Power Down Signal Isolation
- Wide Array of Products such as:
 - Automotive Applications within Grade 1 Temperature Range
 - Industrial Computing/Controls/Automation
 - High Reliability Networking/Communications
 - Industrial/Agricultural Equipment

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

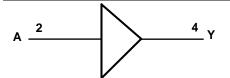
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Pin Descriptions

Pin Name	Description	
NC	No Connection	
Α	Data Input	
GND	Ground	
Υ	Data Output	
Vcc	Supply Voltage	

Logic Diagram



Function Table

Input	Output
Α	Y
Н	Н
L	L

Absolute Maximum Ratings (Notes 4 & 5)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
Vcc	Supply Voltage Range	-0.5 to 6.5	V
Vı	Input Voltage Range	-0.5 to 6.5	V
Vo	Voltage Applied to Output in High Impedance or IOFF State	-0.5 to 6.5	V
Vo	Voltage Applied to Output in High or Low State	-0.5 to V _{CC} + 0.5	V
lık	Input Clamp Current V _I < 0	-50	mA
lok	Output Clamp Current	-50	mA
lo	Continuous Output Current	±50	mA
I _{CC} , I _{GND}	Continuous Current Through V _{CC} or GND	±100	mA
TJ	Operating Junction Temperature	-40 to +150	°C
T _{STG}	Storage Temperature	-65 to +150	°C

Notes:

- 4. Stresses beyond the absolute maximum can result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
- 5. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

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Recommended Operating Conditions (Note 6)

Symbol		Parameter	Min	Max	Unit
\/	Operating Voltage	Operating	1.65	5.5	V
Vcc	Operating voltage	Data retention only	1.5	_	V
		Vcc = 1.65V to 1.95V	0.65 × Vcc	_	
Vih	High-Level Input Voltage	Vcc = 2.3V to 2.7V	1.7	_	V
VIH	High-Level Input voltage	V _{CC} = 3V to 3.6V	2	_	V
		V _{CC} = 4.5V to 5.5V	0.7 × V _{CC}	_	
		V _{CC} = 1.65V to 1.95V	_	0.35 × V _{CC}	
.,	Lavelavellenvt Valtage	V _{CC} = 2.3V to 2.7V	_	0.7	V
VIL	Low-Level Input Voltage	V _{CC} = 3V to 3.6V	_	0.8	V
		Vcc = 4.5V to 5.5V	_	0.3 × Vcc	
Vı	Input Voltage		0	5.5	V
Vo	Output Voltage		0	Vcc	V
		Vcc = 1.65V	_	-4	
	High-Level Output Current	Vcc = 2.3V	_	-8	mA
Іон		Vcc = 2.7V	_	-12	
IOH	riigii-Level Output Current	Vcc = 3V	_	-16	IIIA
		VCC = 3V	_	-24	
		Vcc = 4.5V	_	-32	
		$V_{CC} = 1.65V$	_	4	
		$V_{CC} = 2.3V$	_	8	
lol	Low-Level Output Current	Vcc = 2.7V	_	12	mA
IOL	Low Level Output Ourient	Vcc = 3V	_	16	111/4
		VCC = 3V	_	24	
		Vcc = 4.5V	_	32	
	Innut Transition Disc on Fall	$V_{CC} = 1.8V \pm 0.15V, 2.5V \pm 0.2V$	_	20	
Δt/ΔV	Input Transition Rise or Fall Rate	$Vcc = 3.3V \pm 0.3V$	_	10	ns/V
		$Vcc = 5V \pm 0.5V$	_	5	
TA	Operating Free-Air Temperature	_	-40	+125	°C

Note:

6. Unused inputs should be held at V_{CC} or Ground.



Electrical Characteristics (All typical values are at V_{CC} = 3.3V, T_A = +25°C)

Cumbal	Parameter	Toot Co	n dition o	V	-40°	C to +125	°C	Unit
Symbol	Parameter	Test Conditions		Vcc	Min	Тур	Max	Ollit
		Іон = -100μΑ	1.65V to 5.5V	Vcc - 0.1	_	_		
			I _{OH} = -4mA	1.65V	0.95	_	_	
Vali	High Lovel Output Voltage	VI = VIH	Iон = -8mA	2.3V	1.7	_	_	V
Vон	High Level Output Voltage	VI = VIH	Iон = -12mA	2.7V	1.9	_	_	V
			Iон = -24mA	3V	2.0	_	_	
			I _{OH} = -32mA	4.5V	3.4	_	_	
	V _{OL} Low Level Output Voltage	VI = VIL	I _{OL} = 100μA	1.65V to 5.5V	_	_	0.10	
			I _{OL} = 4mA	1.65V	_	_	0.70	V
.,			IoL = 8mA	2.3V	_	_	0.45	
VoL			I _{OL} = 12mA	2.7V	_	_	0.60	
			I _{OL} = 24mA	3V	_	_	0.80	
			IoL = 32mA	4.5V	_	_	0.80	
lı	Input Current	V _I = 5.5V or GN	ID	0 to 5.5V	_	±0.1	±1	μΑ
loff	Power Down Leakage Current	V_I or $V_O = 5.5V$		0V	_	_	±2	μΑ
Icc	Supply Current	V _I = 5.5V or GND Io = 0		5.5V	_	0.1	4	μΑ
Δlcc	Additional Supply Current	Input at Vcc - 0	Input at Vcc – 0.6V		_	_	500	μΑ
Cı	Input Capacitance	V _I = GND to V _C	С	3.3V	_	5.0	_	pF

Package Characteristics

Symbol	Parameter	Package	Test Conditions	Min	Тур	Max	Unit	
0	Thermal Resistance	SOT25	Note 7	_	184	1	0000	
θ JA	Junction-to-Ambient	SOT353	Note 7	_	385	1	°C/W	
0.10	Thermal Resistance	SOT25	Note 7	_	62	1	°C ///	
θις	Junction-to-Case	SOT353	Note 7	_	164	_	°C/W	

Note: 7. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Switching Characteristics

Figure 1 Typical Values at $T_A = +25^{\circ}C$ and nominal voltages 1.8V, 2.5V, 2.7V, 3.3V, and 5.0V.

Parameter	From	То	Vcc	T _A = -40°C to +125°C			Unit
Farailletei	Input	Output	VCC	Min	Тур	Max	Unit
		A Y	1.8V ± 0.15V	1.0	4.0	11.0	
			2.5V ± 0.2V	0.5	2.6	5.6	
tpD	Α		2.7V	0.5	2.3	5.6	ns
			3.3V ± 0.3V	0.5	2.0	5.2	
			5.0V ± 0.5V	0.5	1.6	4.1	

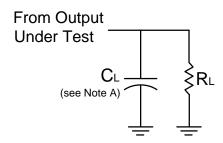
Operating Characteristics

 $T_A = +25^{\circ}C$

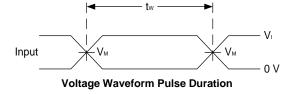
Parameter		Test Conditions	Vcc = 1.8V Typ	Vcc = 2.5V Typ	Vcc = 3.3V Typ	Vcc = 5V Typ	Unit
C _{PD}	Power Dissipation Capacitance	f = 10MHz	15	16	16	16	pF

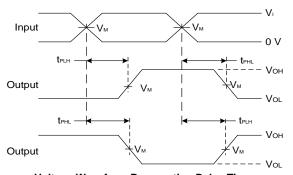


Measurement Information



Vcc	Vcc Inputs V _M		CL	Ru		
VCC	Vı	t _R /t _F	V IVI	OL .	INL	
1.8V ± 0.15V	Vcc	≤2ns	Vcc/2	30pF	1kΩ	
2.5V ± 0.2V	Vcc	≤2ns	Vcc/2	30pF	500Ω	
2.7V	Vcc	≤2.5ns	1.5V	50pF	500Ω	
$3.3V \pm 0.3V$	3.0V	≤2.5ns	1.5V	50pF	500Ω	
5.0V ± 0.5V	Vcc	≤2.5ns	Vcc/2	50pF	500Ω	





Voltage Waveform Propagation Delay Times Inverting and Non Inverting Outputs

Figure 1. Load Circuit and Voltage Waveforms

A. Includes test lead and test apparatus capacitance.

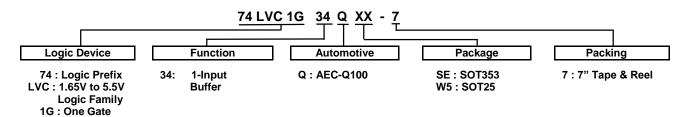
B. All pulses are supplied at pulse repetition rate ≤ 10MHz. Notes:

C. Inputs are measured separately one transition per measurement.

D. t_{PLH} and t_{PHL} are the same as t_{PD} .



Ordering Information (Note 8)



Part Number	Package	Package	Package 7" Tape and Reel		and Reel
Fait Nullibei	Code	(Notes 9 & 10)	Size	Quantity	Part Number Suffix
74LVC1G34QSE-7	SE	SOT353	2.15 mm \times 2.1 mm \times 1.1 mm 0.65 mm lead pitch	3000/Tape & Reel	-7
74LVC1G34QW5-7	W5	SOT25	3.0 mm \times 2.8 mm \times 1.2 mm 0.95 mm lead pitch	3000/Tape & Reel	-7

8. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/. Notes:

9. Pad layout as shown in Diodes Incorporated's package outline PDFs, which can be found on our website at http://www.diodes.com/package-outlines.html.

10. The taping orientation is located on our website at https://www.diodes.com/assets/Packaging-Support-Docs/ap02007.pdf.

Marking Information

(Top View)

XXX2

XXX: Identification Code

Year 0~9

Week: A~Z 1~26 week

a~z 27~52 week z represents week 52 and 53

X : A~ Z: Internal Code

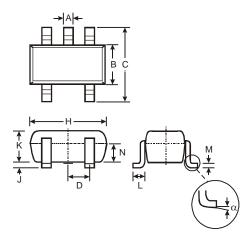
SOT 25 / SOT 353

Part Number	Package	Identification Code
74LVC1G34QW5-7	SOT25	UKQ
74LVC1G34QSE-7	SOT353	UKQ



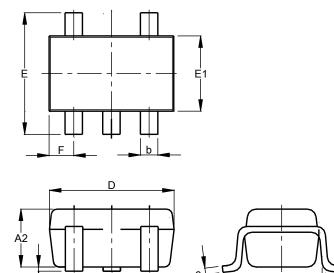
Package Outline Dimensions

(1) Package Type: SOT25



	SOT25						
Dim	Min	Max	Тур				
Α	0.35	0.50	0.38				
В	1.50	1.70	1.60				
С	2.70	3.00	2.80				
D	-	-	0.95				
Н	2.90	3.10	3.00				
J	0.013	0.10	0.05				
K	1.00	1.30	1.10				
L	0.35	0.55	0.40				
M	0.10	0.20	0.15				
N	0.70	0.80	0.75				
α	0°	8°	-				
All D	imensi	ons in	mm				

(2) Package Type: SOT353



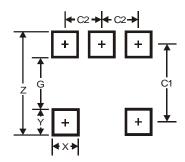
SOT353				
Dim	Min	Max	Тур	
A 1	0.00	0.10	0.05	
A2	0.90	1.00	0.95	
b	0.10	0.30	0.25	
С	0.10	0.22	0.11	
D	1.80	2.20	2.15	
Е	2.00	2.20	2.10	
E1	1.15	1.35	1.30	
е	0.650 BSC			
F	0.40	0.45	0.425	
L	0.25	0.40	0.30	
а	0°	8°		
All Dimensions in mm				



Suggested Pad Layout

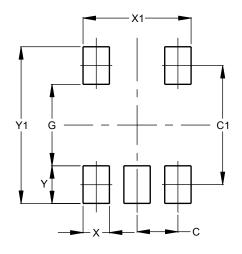
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SOT25



Dimensions	Value
Z	3.20
G	1.60
X	0.55
Y	0.80
C1	2.40
C2	0.95

(2) Package Type: SOT353



Dimensions	Value (in mm)
С	0.650
C1	1.900
G	1.300
Х	0.420
X1	1.720
Y	0.600
Y1	2.500

Mechanical Data

SOT25

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208@3
- Weight: 0.0158 grams (Approximate)

SOT353

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0064 grams (Approximate)

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